

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD disks::	
Number of Copies of CDs::	
Sequence Submission?::	None
Computer Readable Form (CRF)::	No
Number of copies of CRF::	0
Title::	MOUNTING STRUCTURE OF SEMICONDUCTOR DEVICE AND MOUNTING METHOD THEREOF
Attorney Docket Number::	8001-1049-1
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	5
Small Entity?::	No
Latin Name::	
Variety Denomination Name::	
Petition Included?::	No
Petition Type::	
Licensed US Gov't Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: HIROKAZU
Middle Name::
Family Name:: MIYAZAKI
Name Suffix::
City of Residence:: TOKYO
State or Province of
Residence::
Country of Residence:: JAPAN
Street of Mailing 7-1, SHIBA 5-CHOME
Address:: MINATO-KU
City of Mailing Address:: TOKYO
State or Province of Mailing Address::
Country of Mailing Address:: JAPAN
Postal or Zip Code of Mailing Address::

Correspondence Information

Correspondence Customer 000466
Number::

Representative Information

Representative Customer	000466
Number::	

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	Division of	09/788,596	2/21/01

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2000-049904	2/25/00	Yes

Assignment Information

Assignee Name:: NEC CORPORATION

Street of Mailing 7-1, SHIBA 5-CHOME

Address:: MINATO-KU

City of Mailing Address:: TOKYO

State or Province of Mailing Address::

Country of Mailing Address:: JAPAN

Postal or Zip Code of Mailing Address::